

# Quick start guide

## KIT\_DRIVER\_2EDN7524R

August 2018





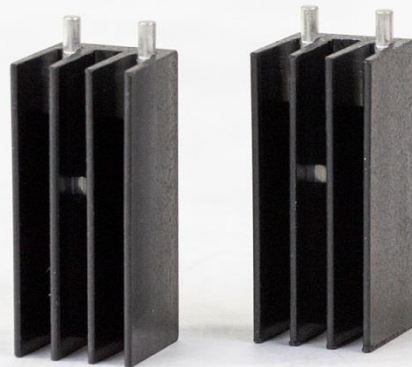
# KIT\_DRIVER\_2EDN7524R





# Included in this kit

Evaluation kit  
KIT\_DRIVER\_2EDN7524R



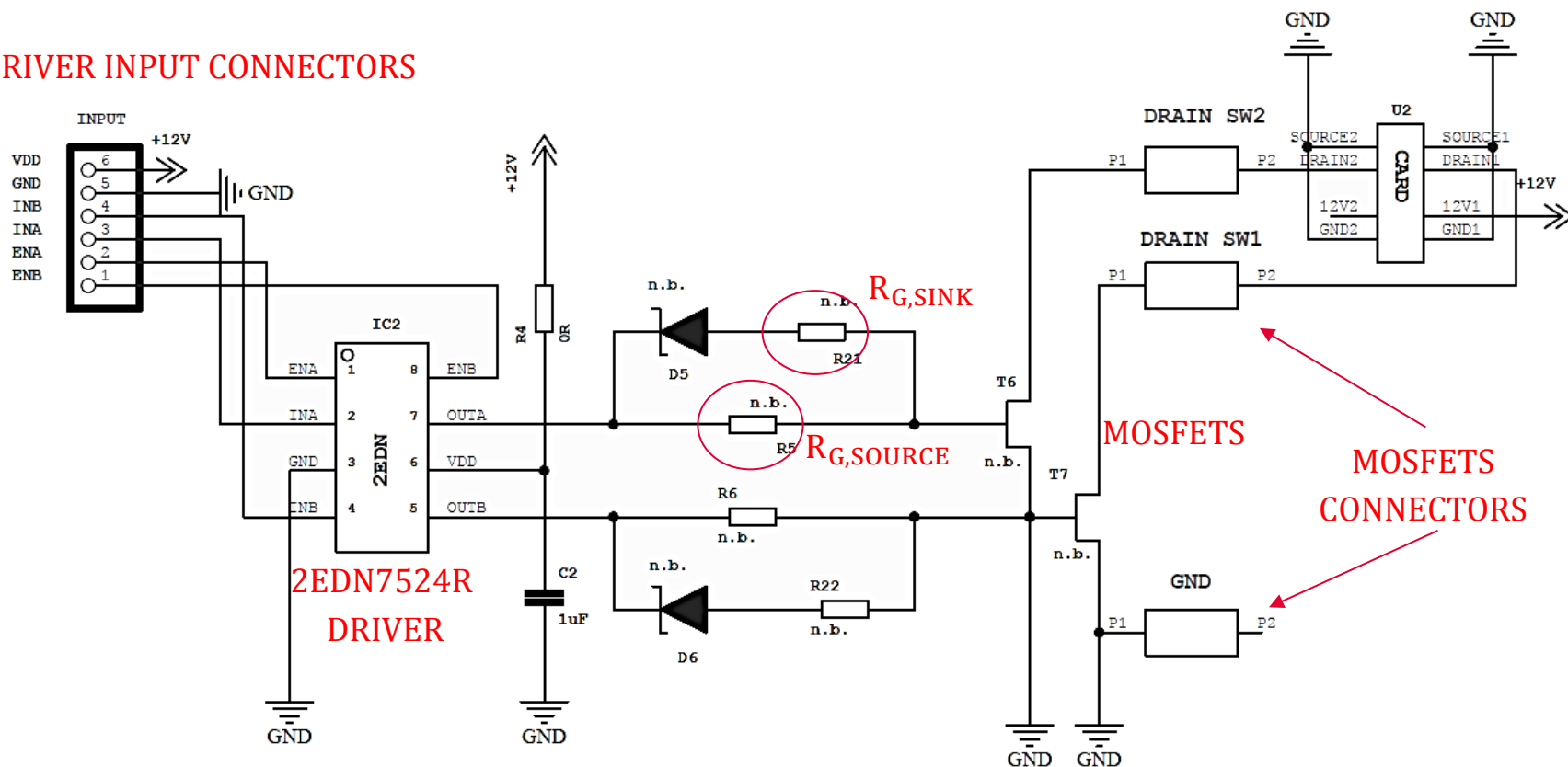
Heatsinks for  
TO-220 MOSFETs





# Board schematic

## DRIVER INPUT CONNECTORS








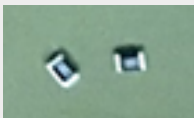


## HEATSINKS



**n.d.** = value **not defined**, component not populated on the PCB



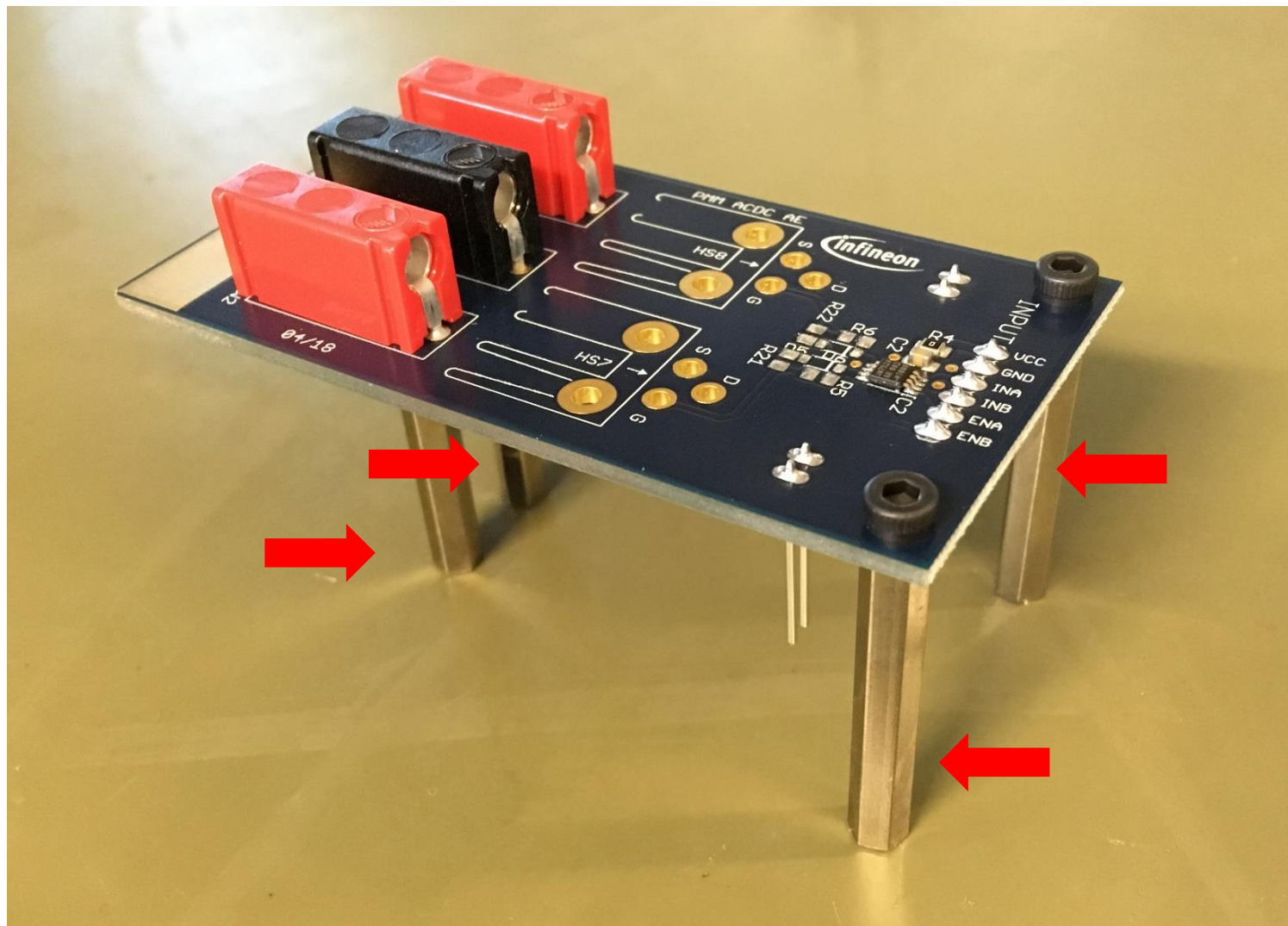
# Components to add – BOM suggestion

Distance bolts	Screws for distance bolts	Screws and washers for MOSFET mounting to heatsink	TO-220 sockets
			
TO-220 MOSFETs	Source resistors (R5, R6)	Sink resistors (R21, R22)	Sink diodes
			

Component	Quantity	Designator	Comment	Voltage	Footprint	Type	Part number/ supplies
Sink diode	2	D5,D6	Schottky diode	30 V	SOD-123	PMEG3020 Schottky diode	816-6858 RS-Components
Resistors	4	R5,R6,R21,R22			RES805R	SMD ceramic resistor	
TO-220 sockets	2	T6,T7	TO-220 socket		TO-220	Receptacle Connector 0.034" ~ 0.041" (0.86 mm ~ 1.04 mm)	5050865-5 Digi-key

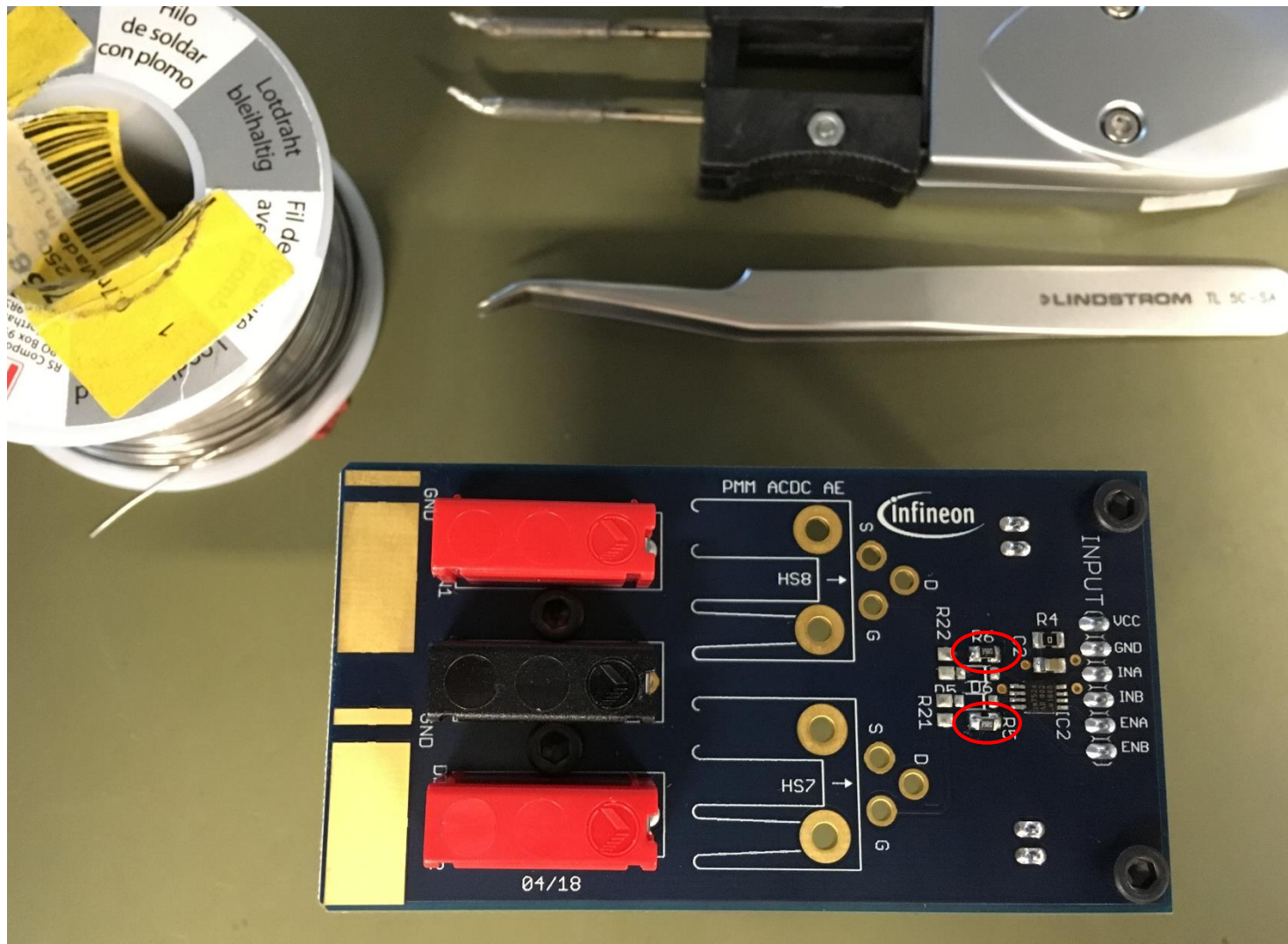


# Step 1: Distance bolts mounting





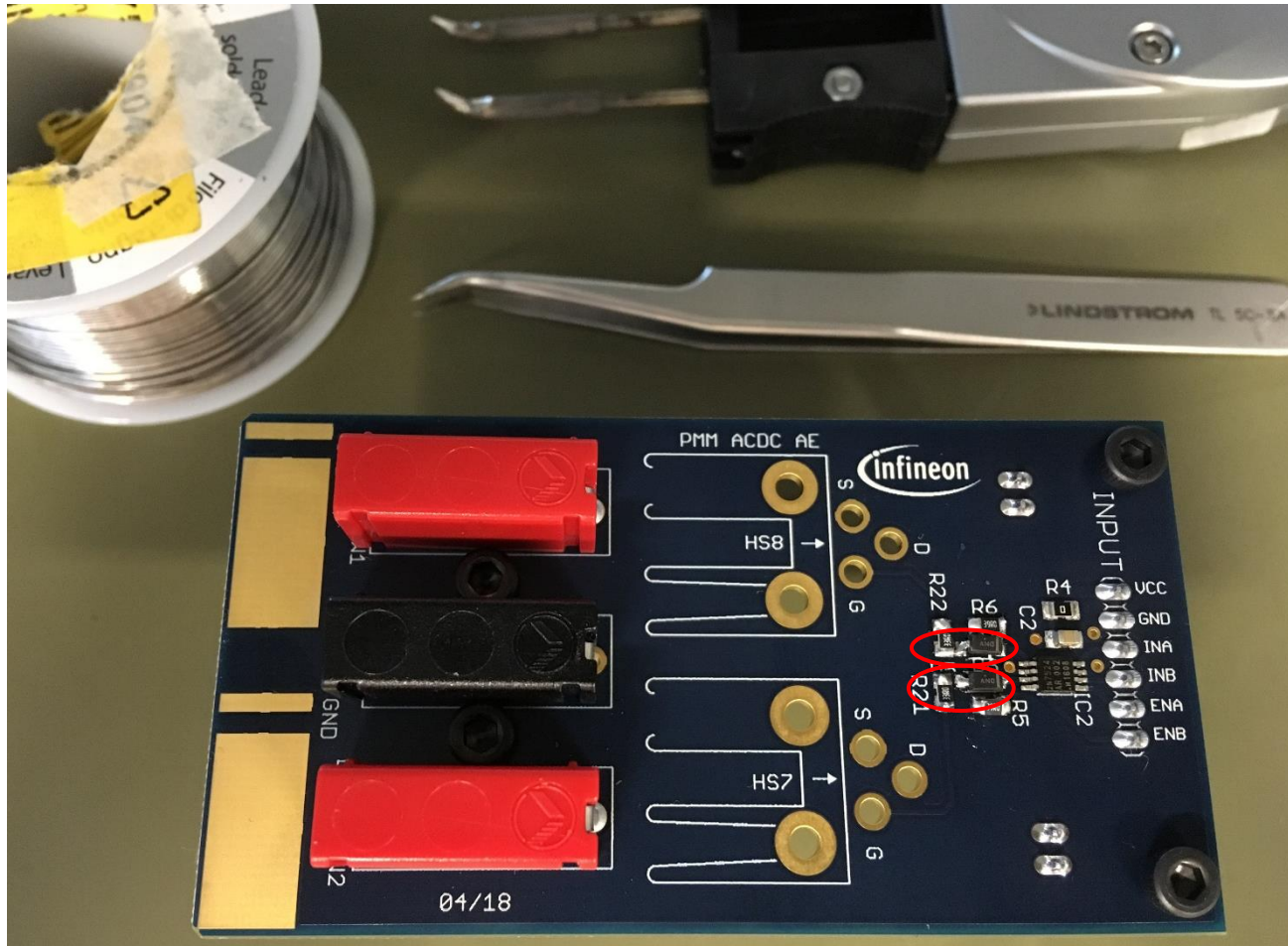
## Step 2: Source resistors soldering





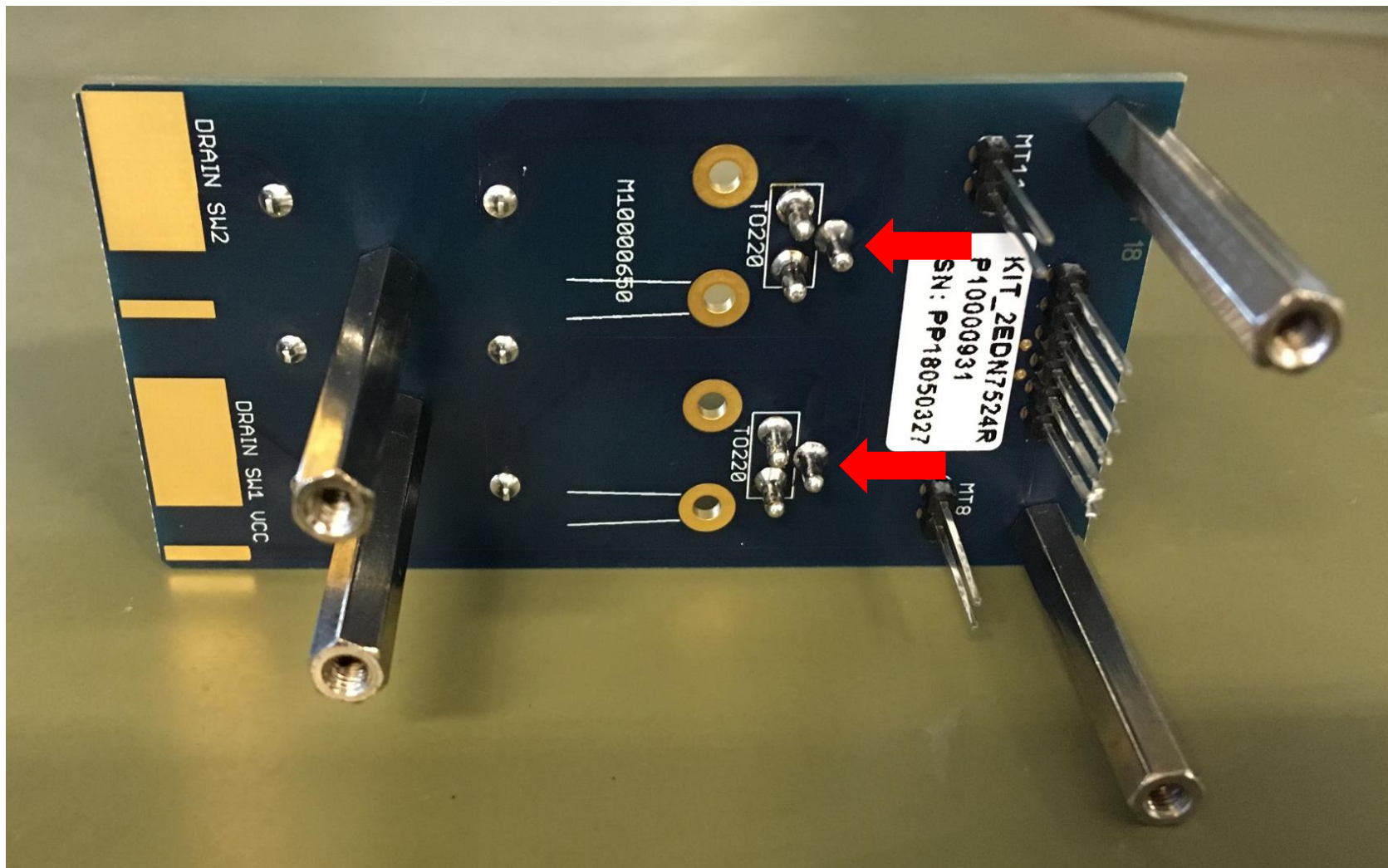
# Step 3: Sink resistors and sink diodes soldering

- > Add the sink resistors and the sink diodes only if a differentiation between the turn-on and the turn-off behavior is required



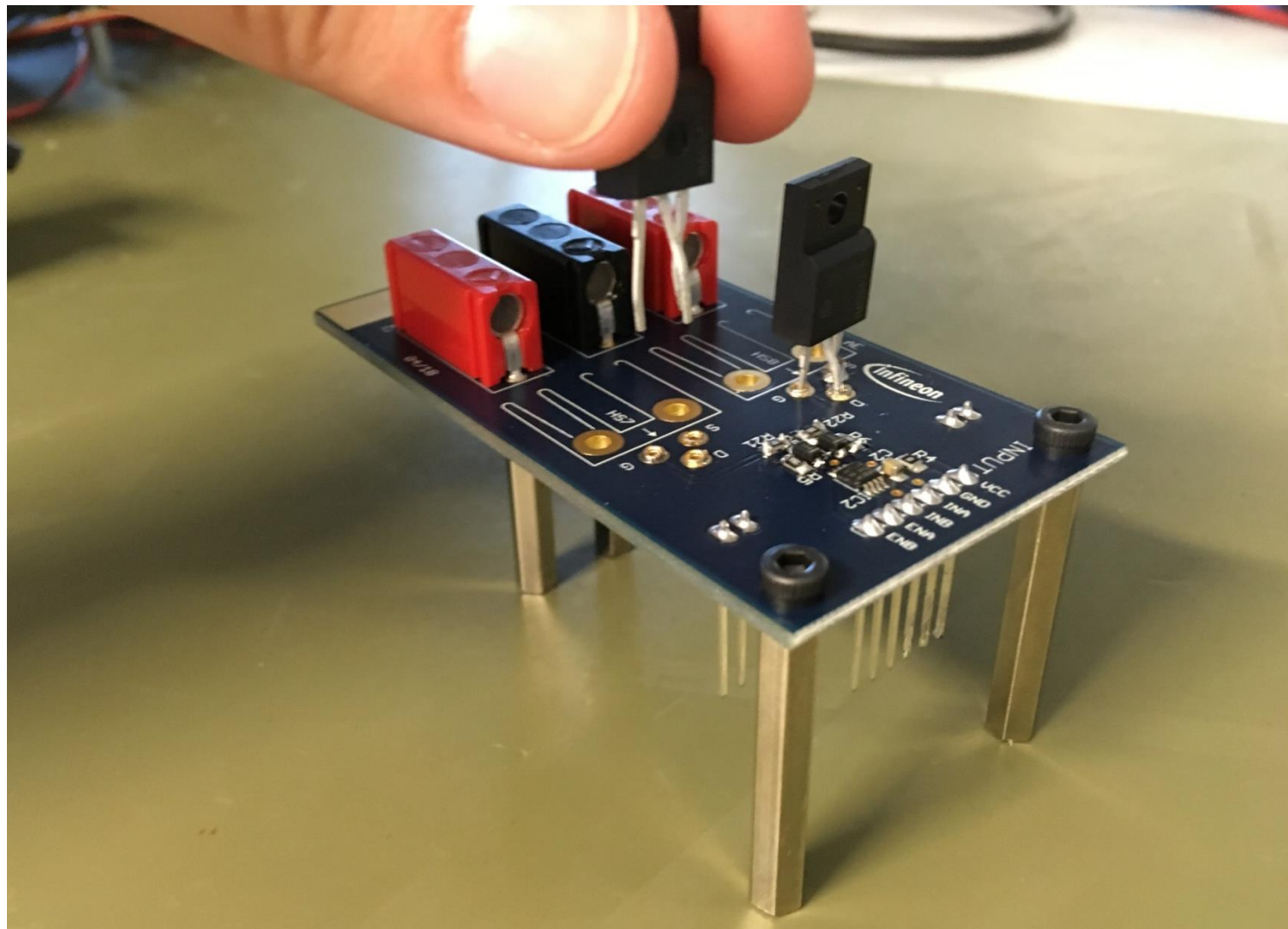


## Step 4: TO-220 sockets soldering





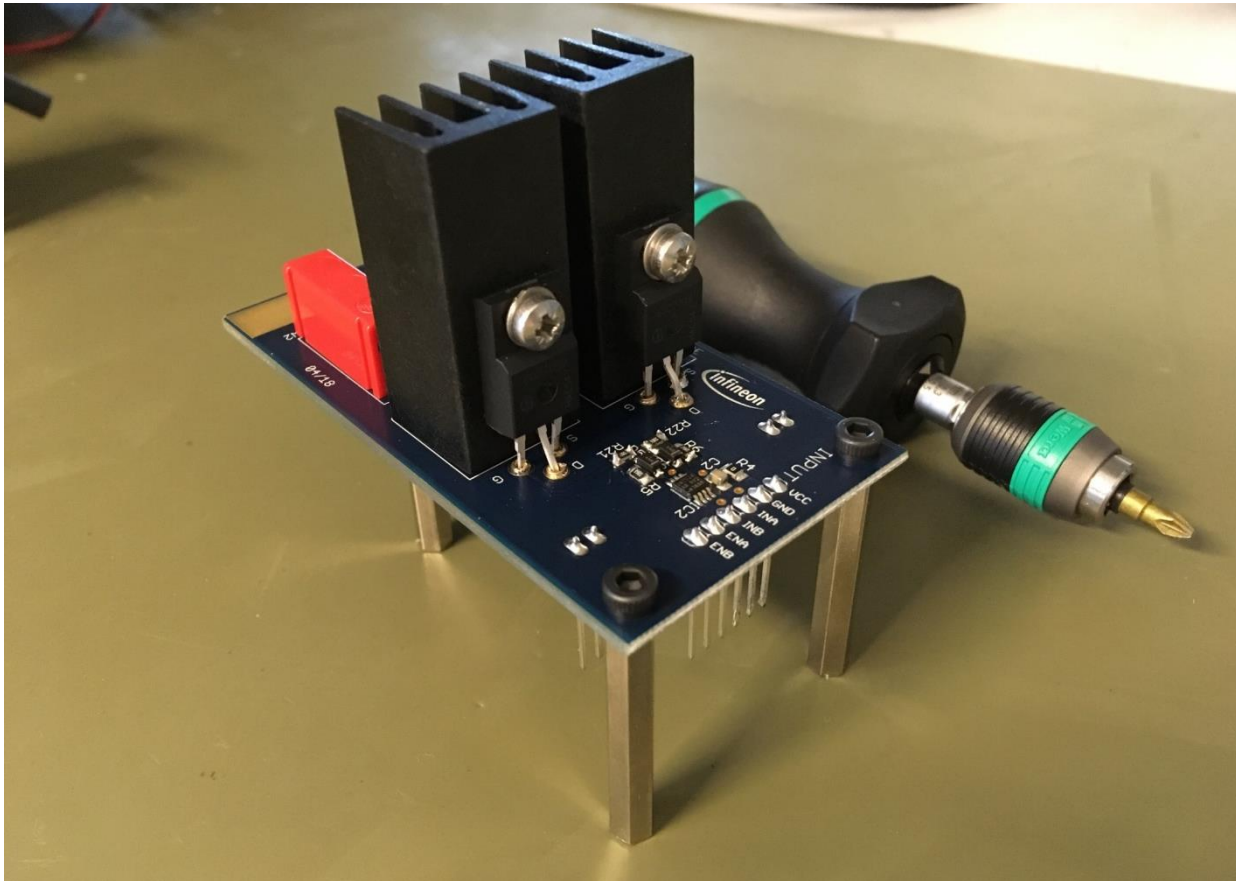
## Step 5: MOSFETs placement into the sockets





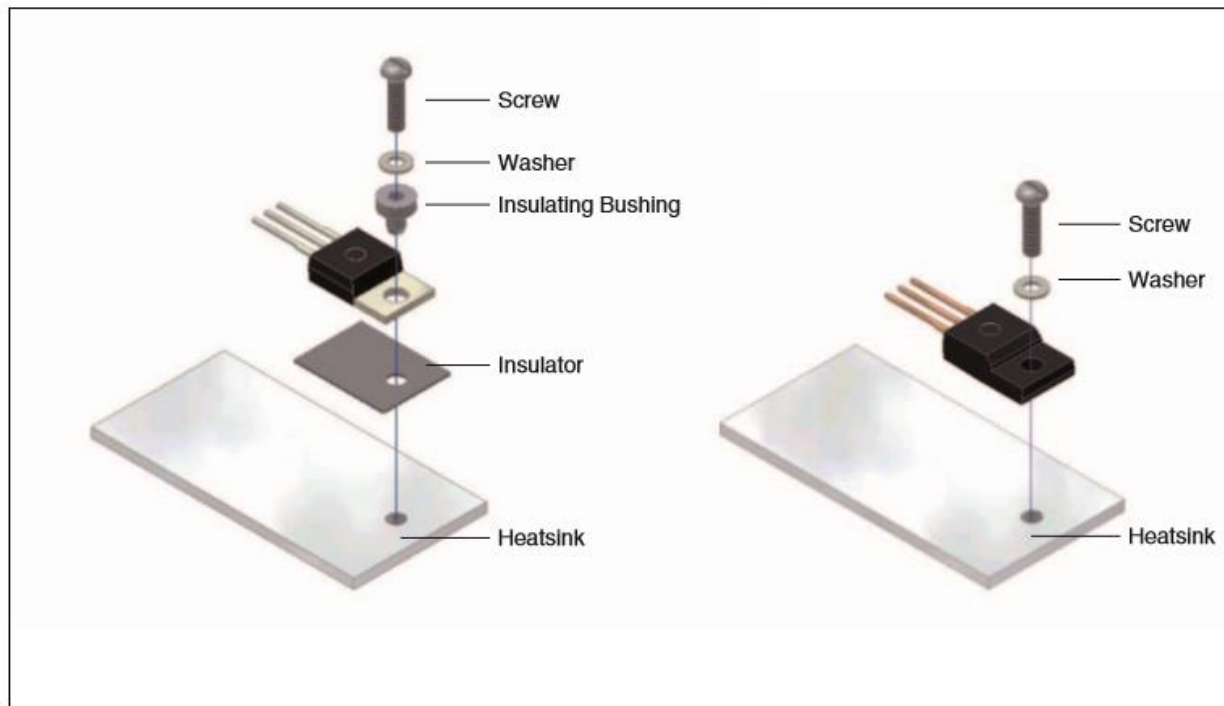
## Step 6: Heatsink mounting (optional)

- > Solder the heatsink if the board is used in high voltage scenarios
- > In basic measurements it is not necessary
- > See next slide for further information on how to properly mount the MOSFETs to the heatsink





# TO-220 MOSFET mounting to the heatsink

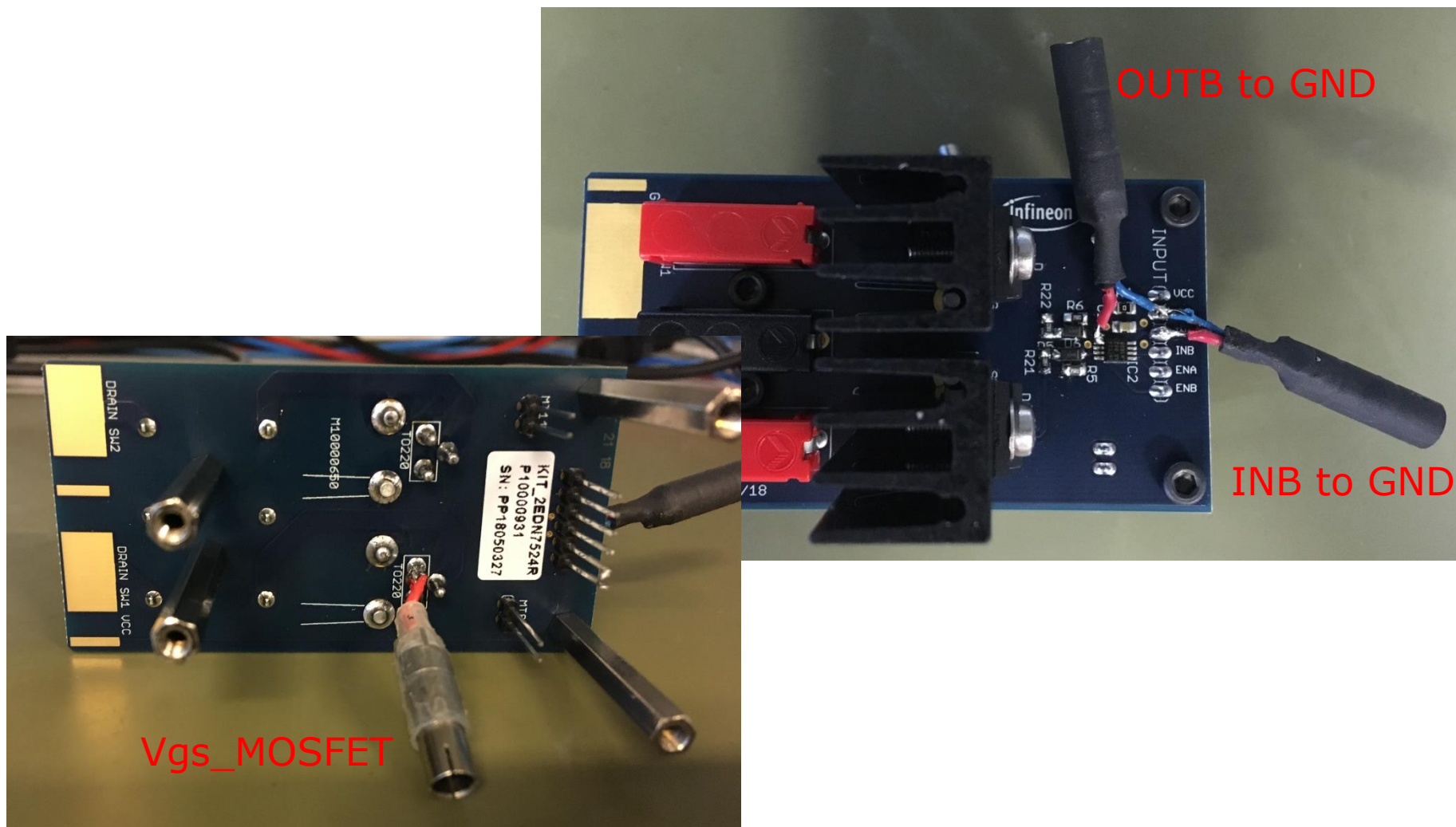


Package	Typ. Torque [Nm]	Max. Torque [Nm]	Comment
PG-TO220	0.6	0.7	Screw M3
PG-TO220 FullPAK	0.5	0.7	Screw M2.5

- > Recommendations for assembly of Infineon TO packages:  
[https://www.infineon.com/dgdl/Infineon-Package\\_recommendations\\_for\\_assembly\\_of\\_Infineon\\_TO\\_packages-AN-v01\\_00-EN.pdf?fileId=db3a30431936bc4b011938532f885a38](https://www.infineon.com/dgdl/Infineon-Package_recommendations_for_assembly_of_Infineon_TO_packages-AN-v01_00-EN.pdf?fileId=db3a30431936bc4b011938532f885a38)



# Step 7: BNC connectors soldering



- > N.B. Please note that the silkscreen labels for INA and INB are merged



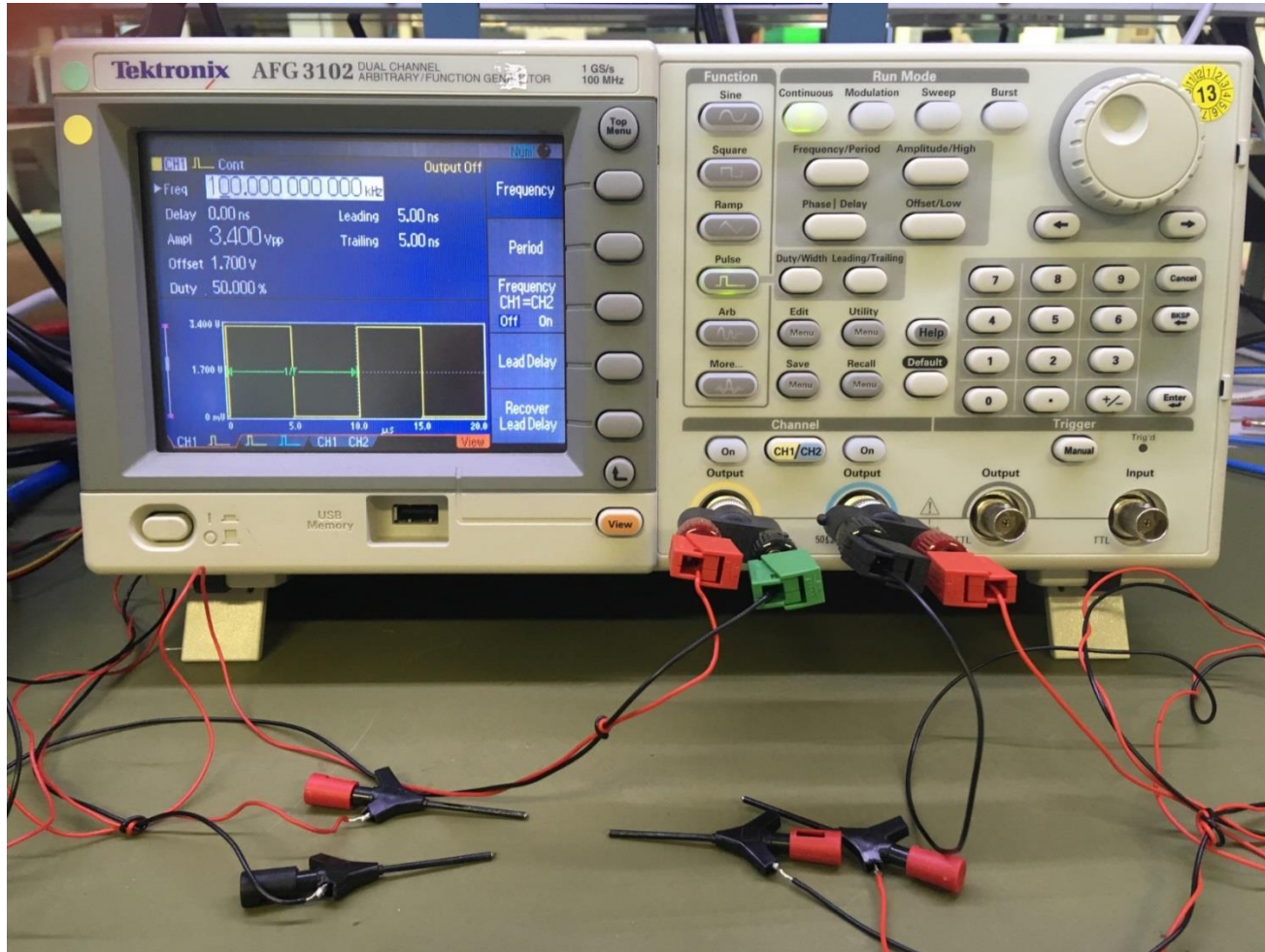
# Instrumentation for driver supply generation



- >  $V_{CC}$  = 12 V for CoolMOS™ and 8 V for OptiMOS™
- > Set the current limit below 1 A (0.8 A e.g.)



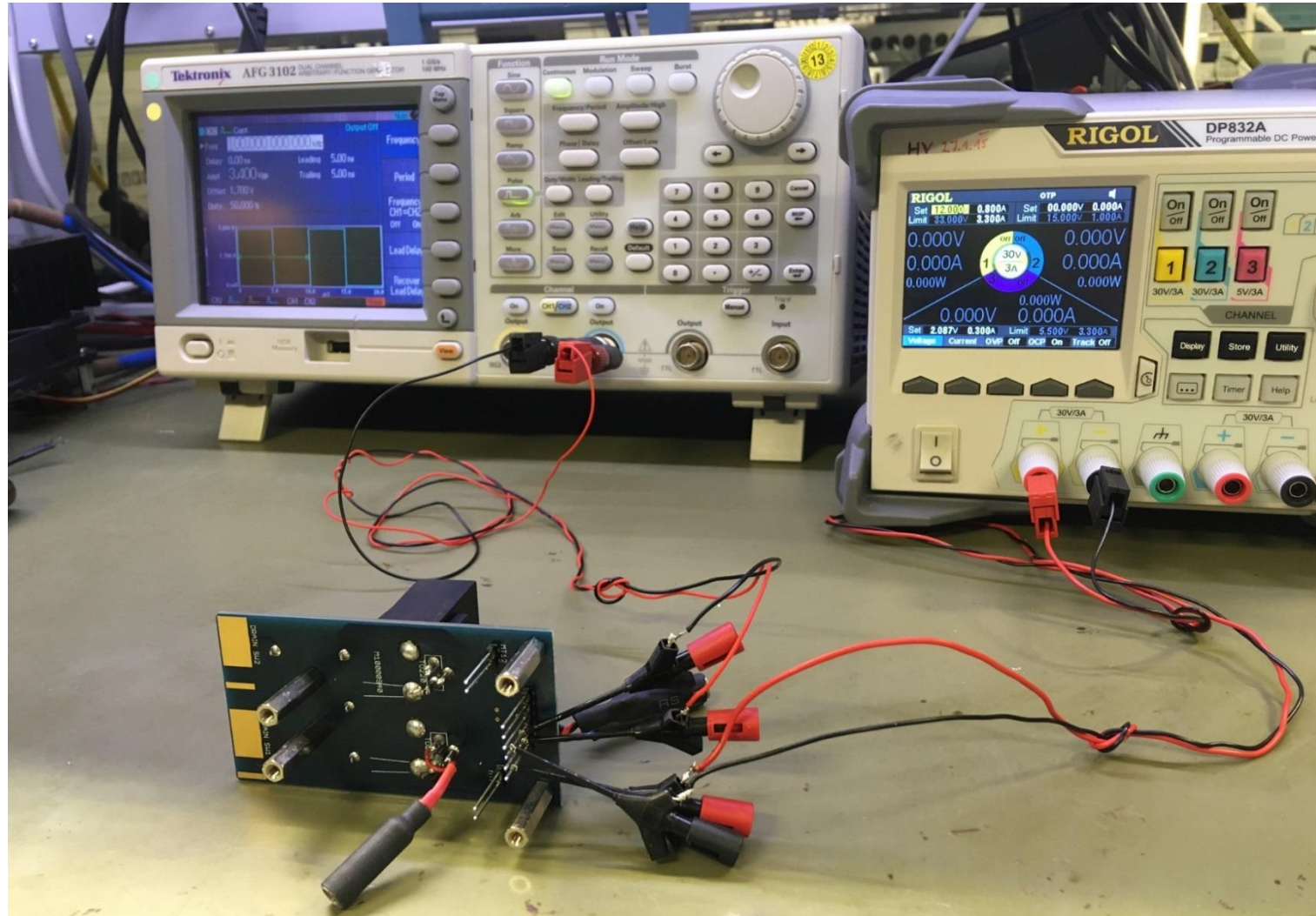
# Instrumentation for PWM signals generation



- Use a function generator or a microcontroller

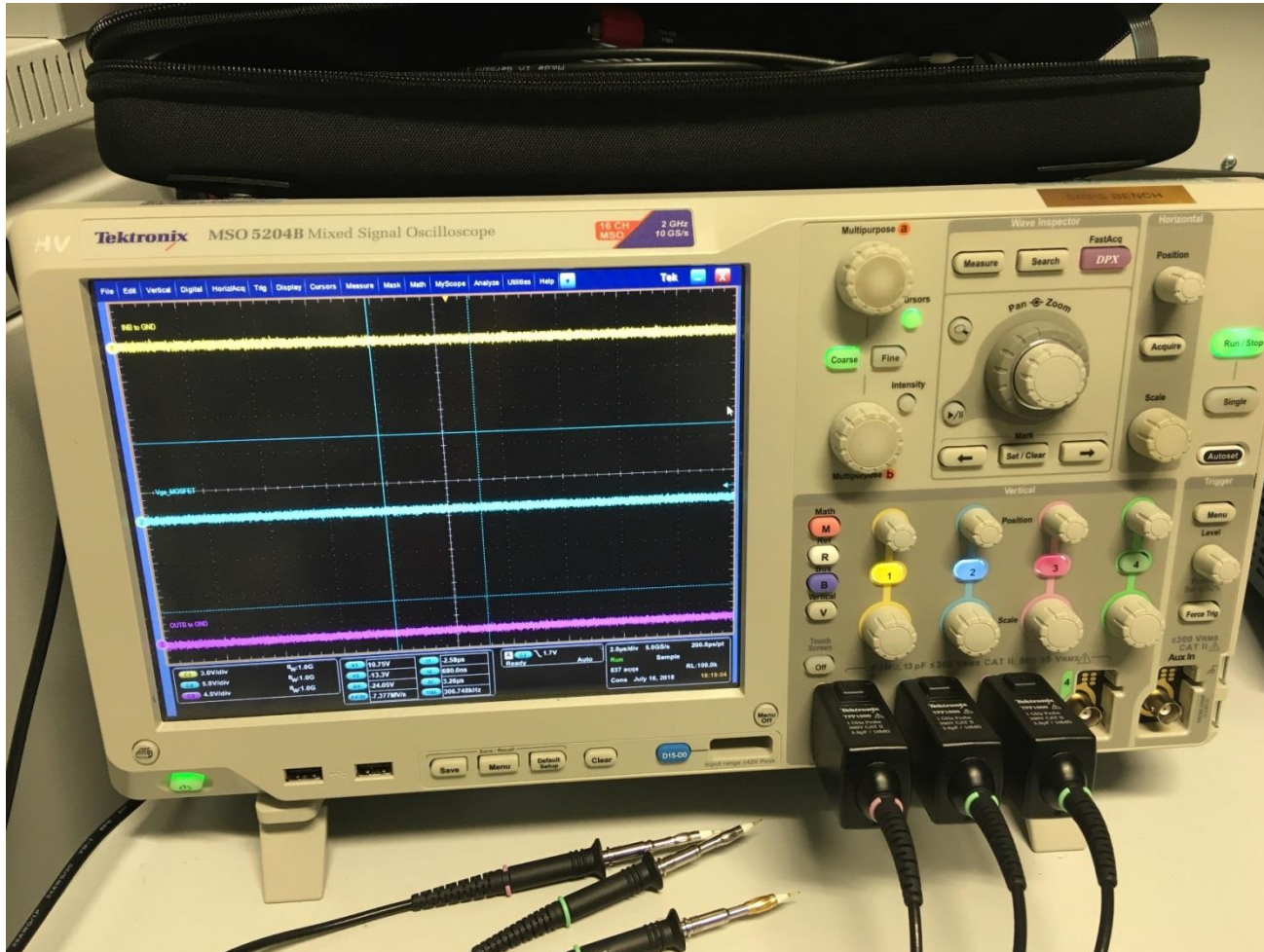


# Connections





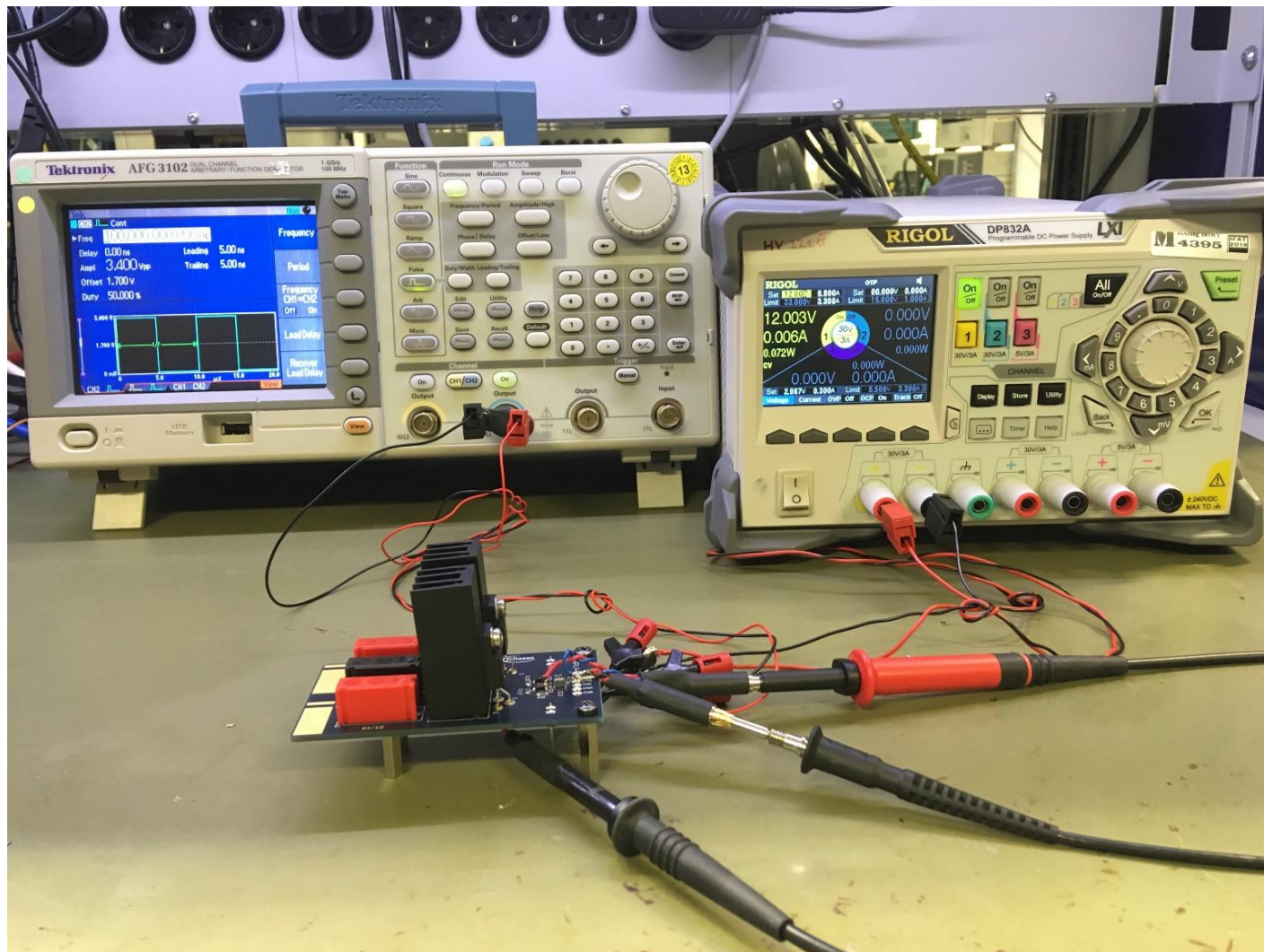
# Instrumentation for signals evaluation



- Voltage probes used: Tetronix TPP1000 1 GHz, 3.9 pF

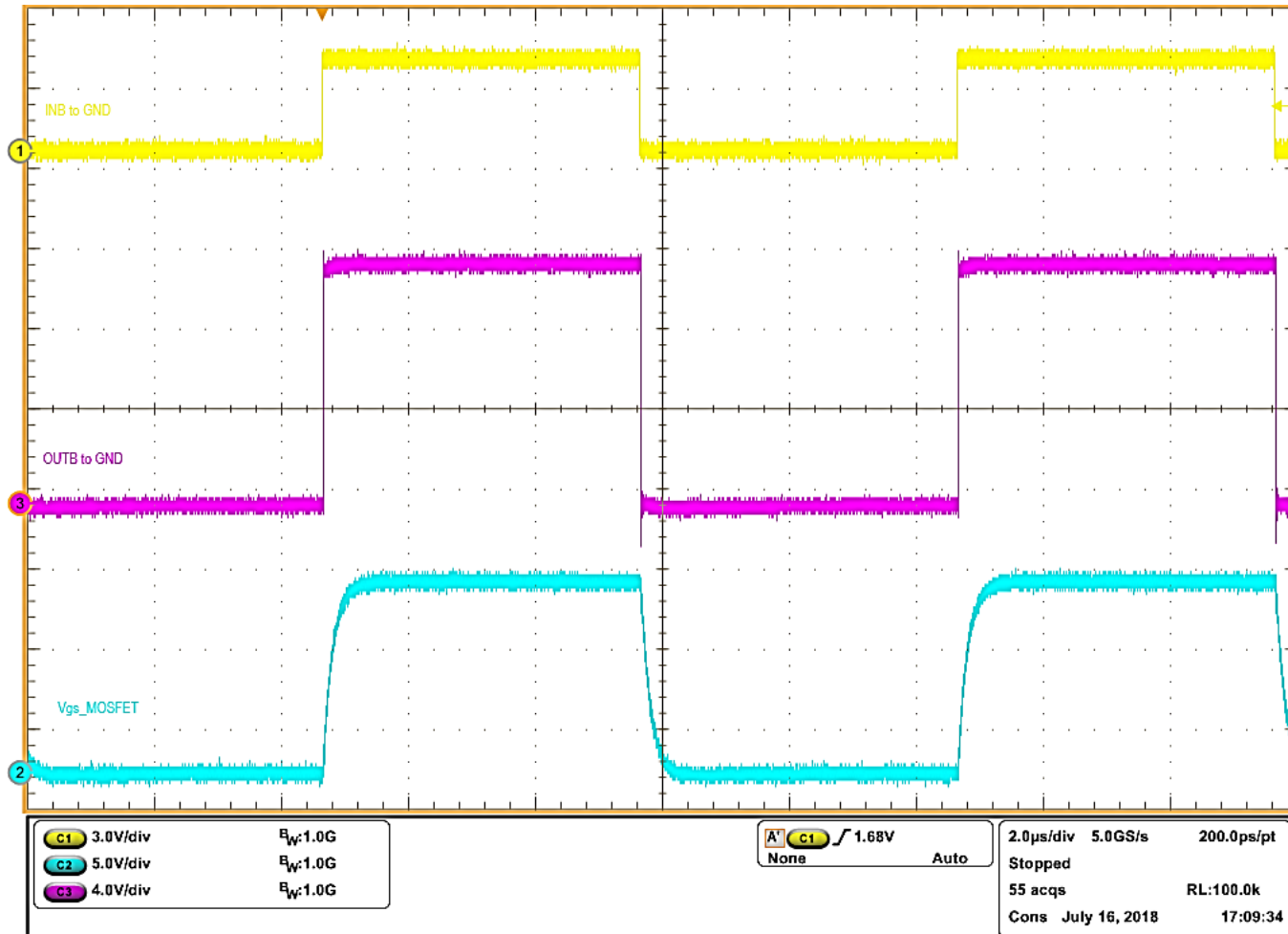


# Complete measurement setup





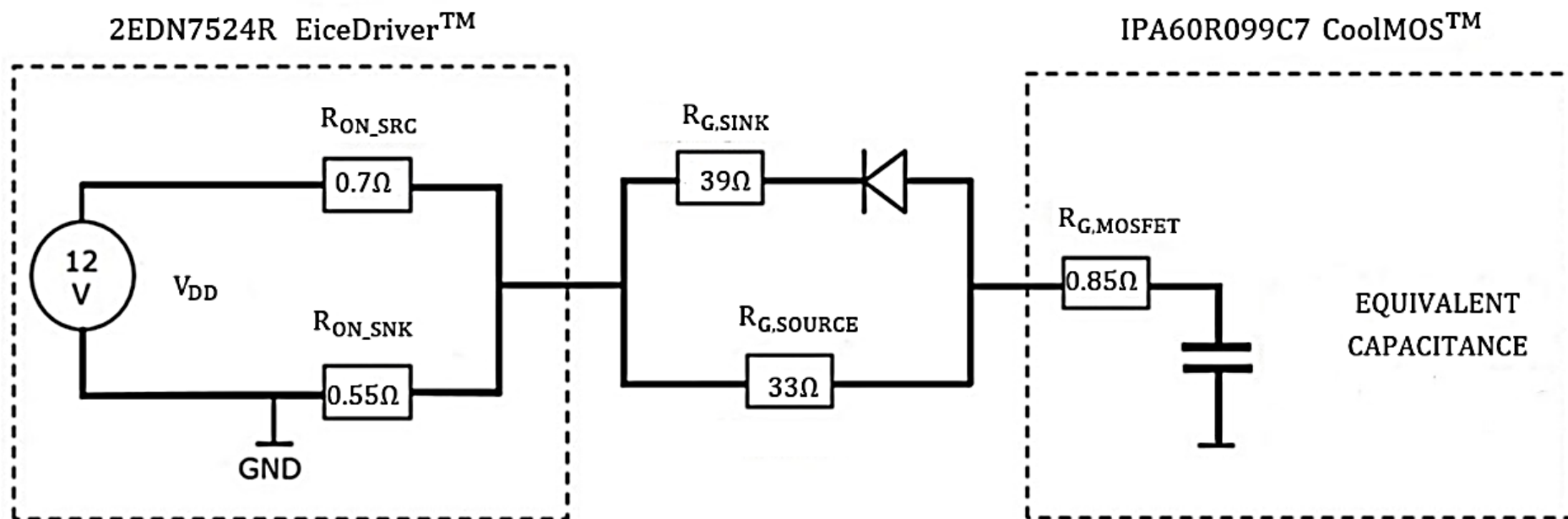
# Oscilloscope waveforms



- > Measurements done on a single MOSFET with  $V_{DS} = 0\text{ V}$  (drain and source shorted)

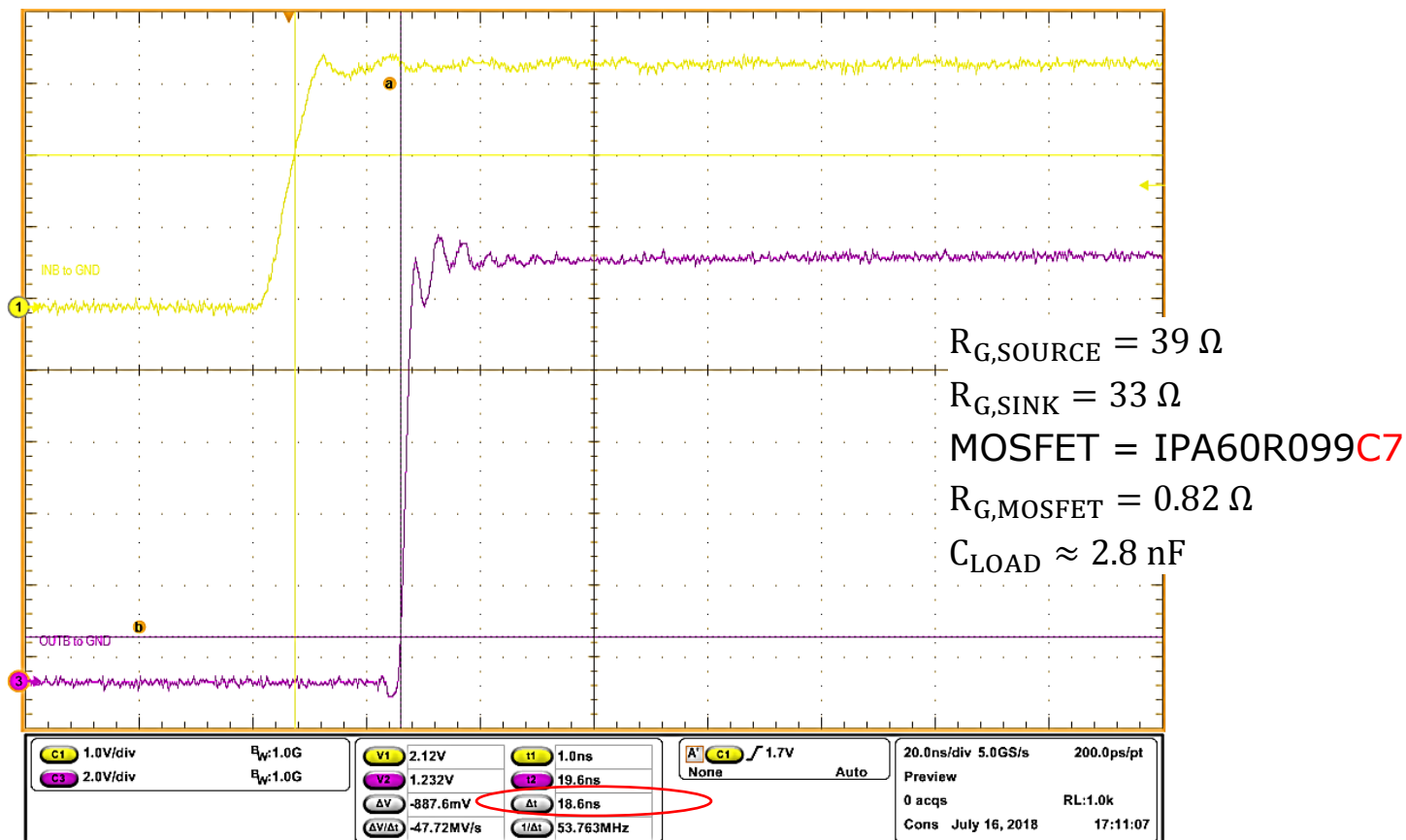


# Equivalent model of the driving circuit





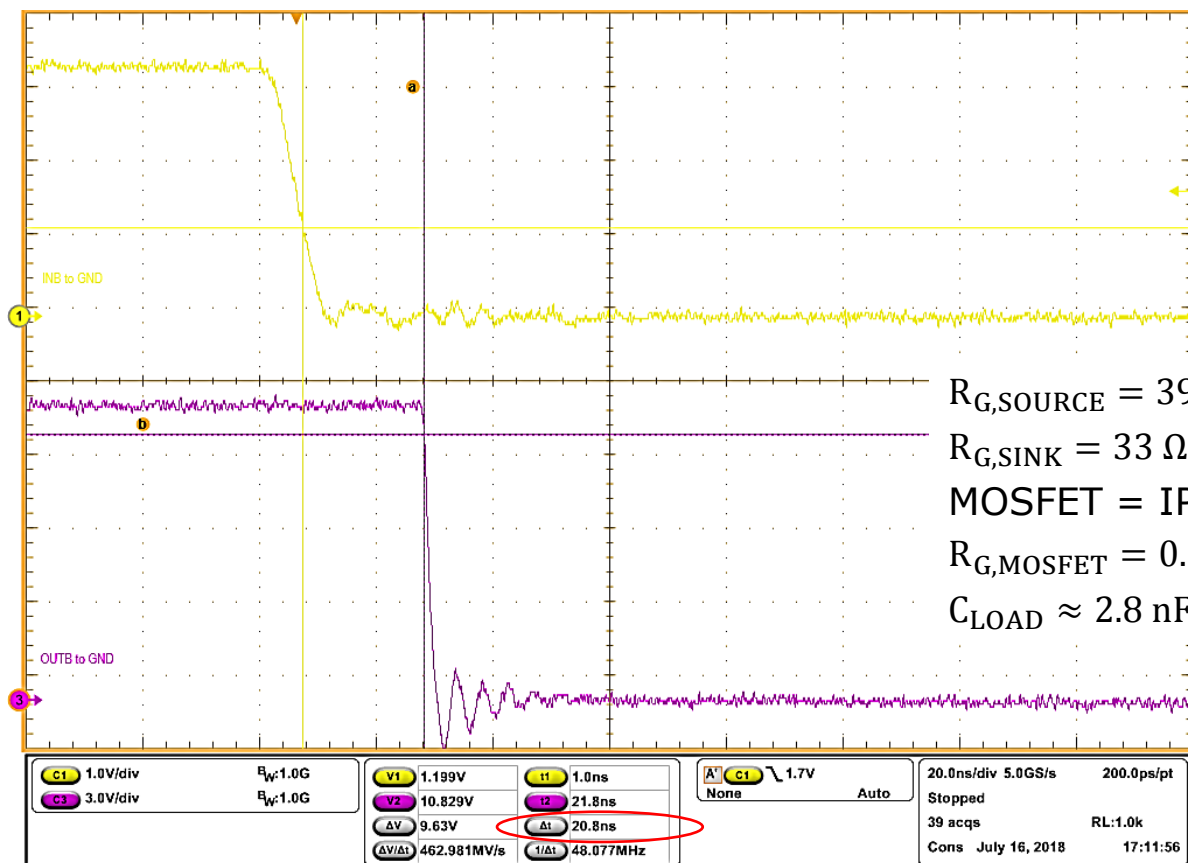
# Low-high propagation delay



- >  $t_{PDlh}$  defined in the datasheet as time interval  $t(OUTB = 10\% VDD) - t(INB = V_{INH} = 2.1 \text{ V})$  for a pure capacitive load  $C_{LOAD} = 1.8 \text{ nF}$  with  $R_{G,SOURCE} = 0 \Omega$
- > N.B. In the considered measurements the load is the transistor with  $R_{G,MOSFET} = 0.82 \Omega$ ,  $R_{G,SOURCE} = 39 \Omega$ ,  $C_{LOAD} \approx 2.8 \text{ nF}$  (see slide 23 for  $C_{LOAD}$  calculation)



# High-Low propagation delay



$R_{G,SOURCE} = 39 \Omega$

$R_{G,SINK} = 33 \Omega$

MOSFET = IPA60R099C7

$R_{G,MOSFET} = 0.82 \Omega$

$C_{LOAD} \approx 2.8 \text{ nF}$

- >  $t_{PDhl}$  defined in the datasheet as time interval  $t(\text{OUTB} = 90\% \text{ VDD}) - t(\text{INB} = V_{INL} = 1.02 \text{ V})$  for a pure capacitive load  $C_{LOAD} = 1.8 \text{ nF}$  with  $R_{G,SINK} = 0 \Omega$
- > N.B. In the considered measurements the load is the transistor with  $R_{G,MOSFET} = 0.82 \Omega$ ,  $R_{G,SINK} = 33 \Omega$ ,  $C_{LOAD} \approx 2.8 \text{ nF}$



# $C_{LOAD}$ calculation for IPA60R099C7



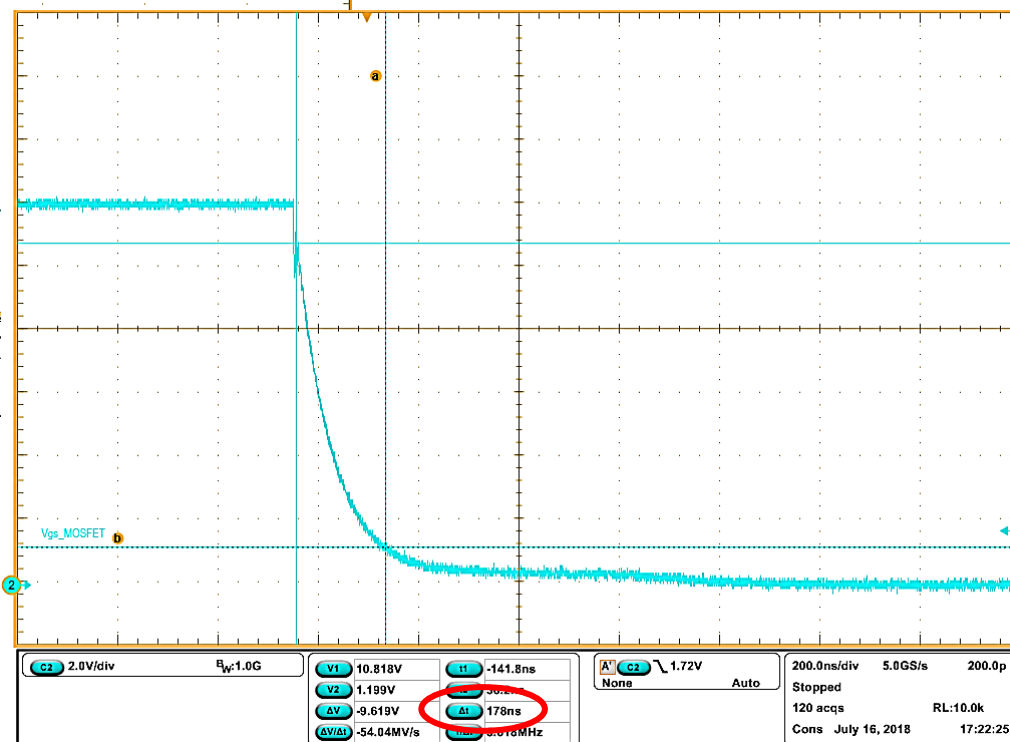
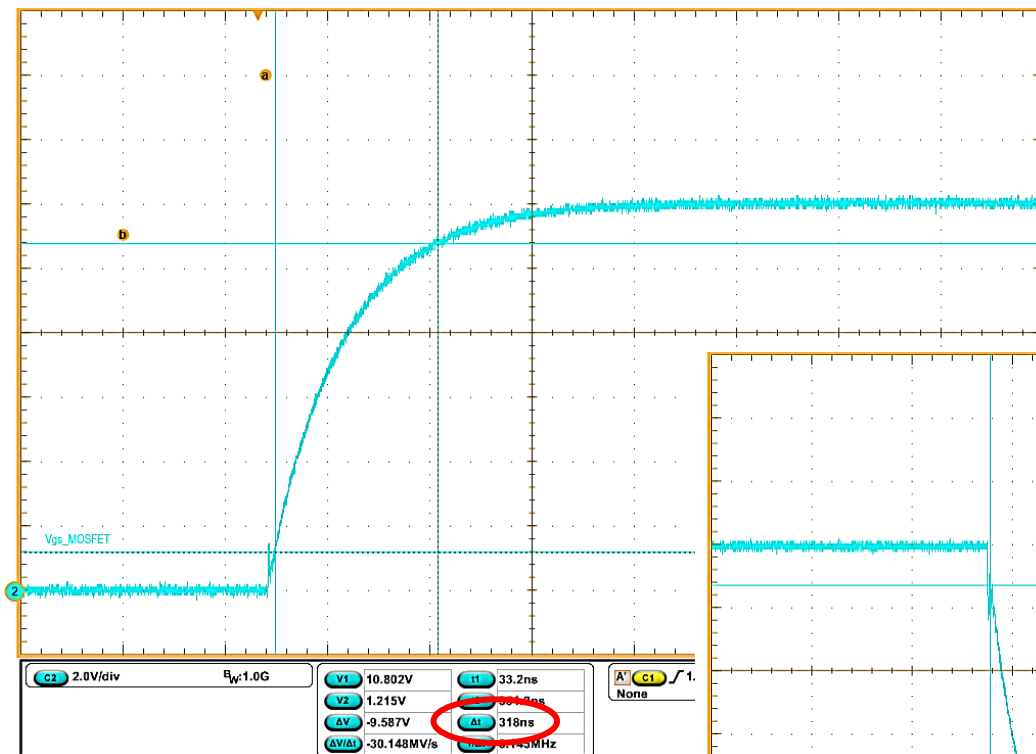
Gate to drain charge	$Q_{gd}$	-	14	-	nC	$V_{DD}=400V, I_D=9.7A, V_{GS}=0 \text{ to } 10V$
Gate charge total	$Q_g$	-	42	-	nC	$V_{DD}=400V, I_D=9.7A, V_{GS}=0 \text{ to } 10V$

$$Q_{LOAD} = Q_g - Q_{gd} = 28 \text{ nC} \rightarrow C_{LOAD} = \frac{Q_{LOAD}}{V_{GS}} = 2.8 \text{ nF} \text{ for } V_{GS} = 10 \text{ V} \rightarrow$$

$$C_{LOAD} \approx 2.8 \text{ nF} \text{ for } V_{GS} = 12 \text{ V}$$



# Rise/fall times





# Gate resistors replacement

$$R_{G,SOURCE} = 39 \, \Omega \quad \rightarrow \quad 24 \, \Omega$$

$$R_{G,SINK} = 33 \, \Omega \quad \rightarrow \quad 20 \, \Omega$$

MOSFET = IPA60R099C7



# Rise/fall times: New set of gate resistances

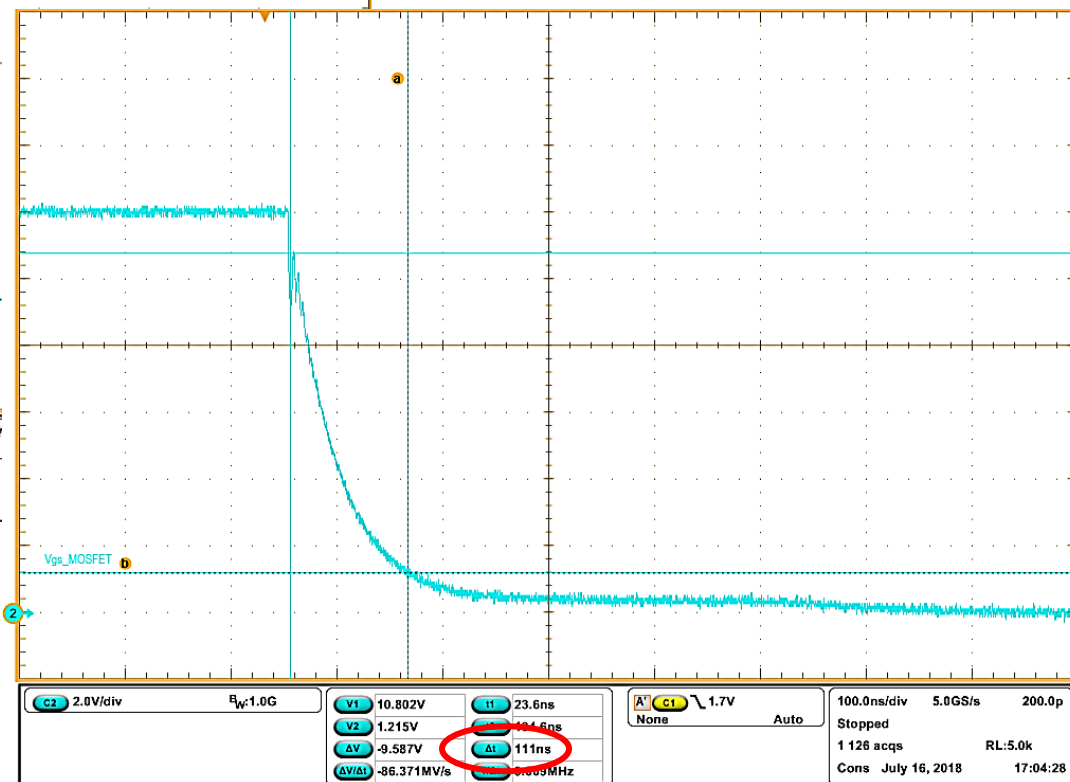
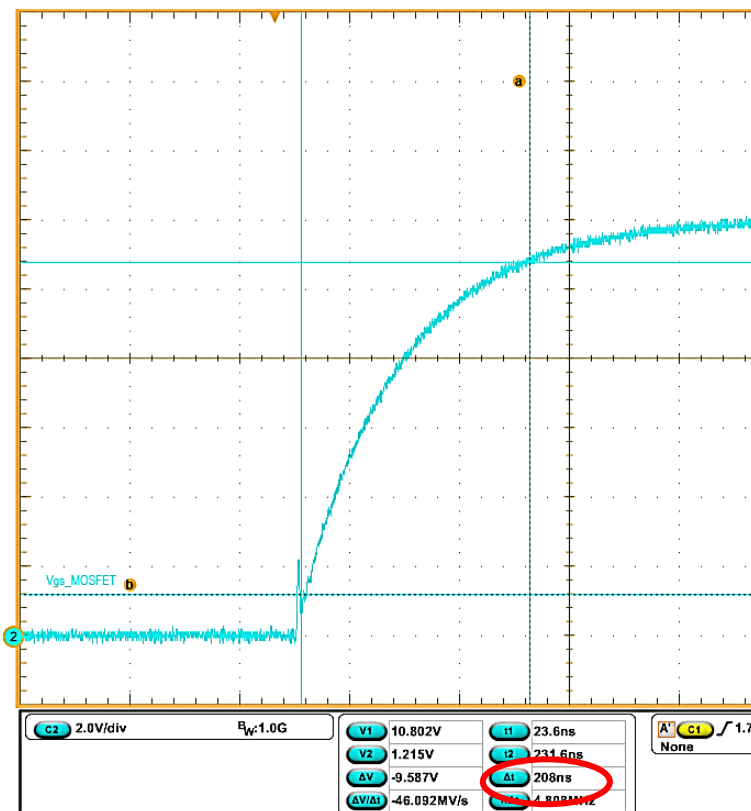
$$R_{G,SOURCE} = 24 \Omega$$

$$R_{G,SINK} = 20 \Omega$$

MOSFET = IPA60R099C7

$$R_{G,MOSFET} = 0.82 \Omega$$

$$C_{LOAD} \approx 2.8 \text{ nF}$$





# Gate resistors replacement

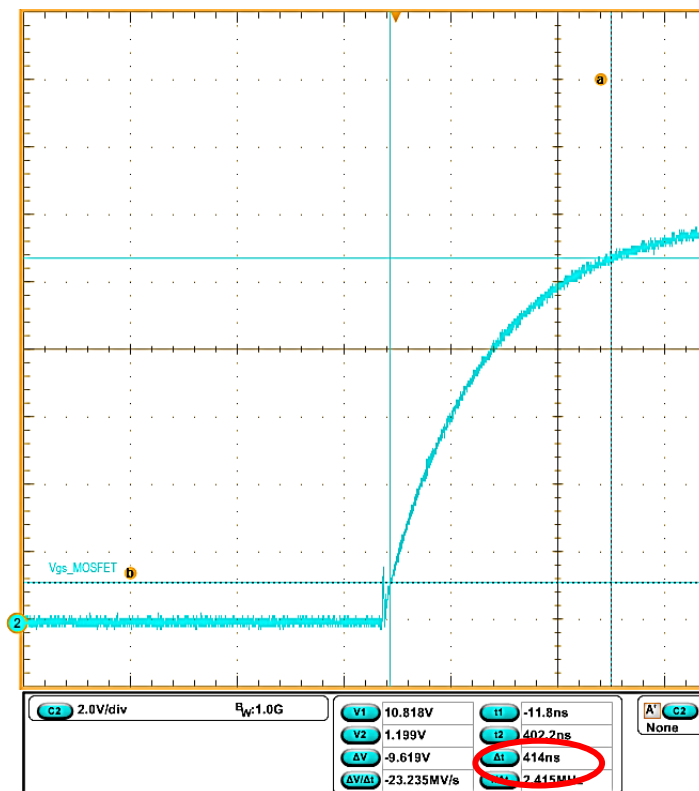
$$R_{G,SOURCE} = 24 \, \Omega \quad \rightarrow \quad 51 \, \Omega$$

$$R_{G,SINK} = 20 \, \Omega \quad \rightarrow \quad 43 \, \Omega$$

MOSFET = IPA60R099C7



# Rise/fall times: New set of gate resistances



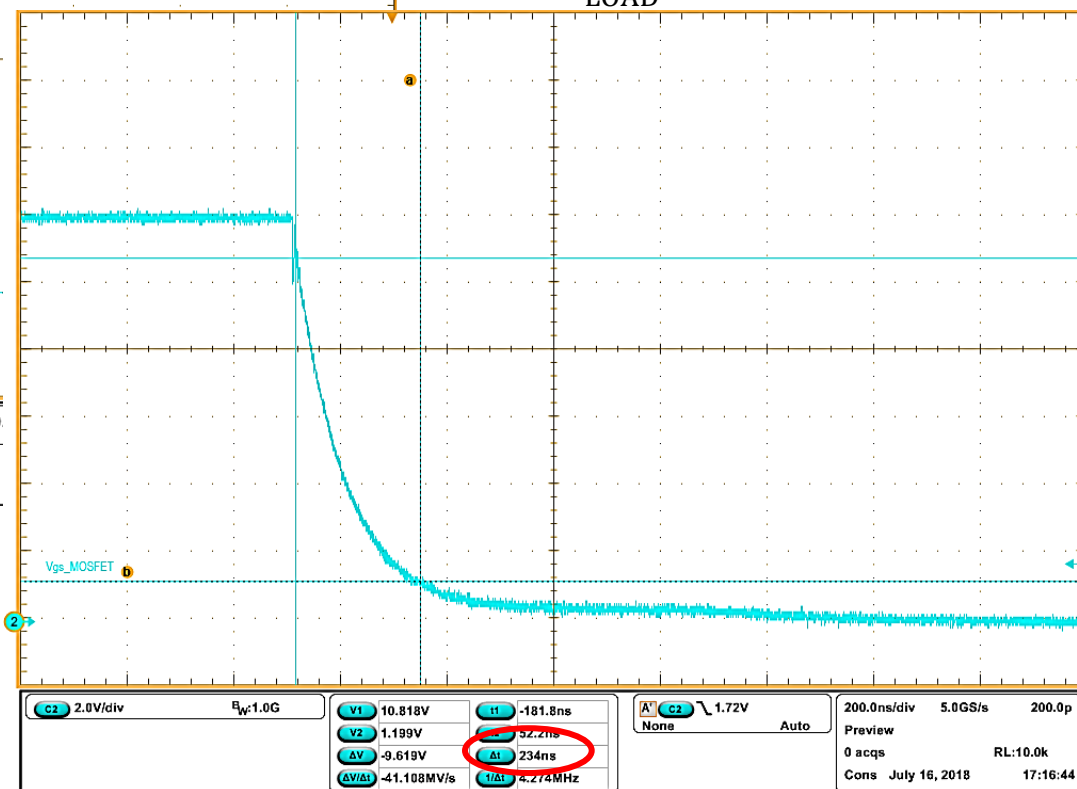
$$R_{G,SOURCE} = 51 \Omega$$

$$R_{G,SINK} = 43 \Omega$$

MOSFET =  
IPA60R099C7

$$R_{G,MOSFET} = 0.82 \Omega$$

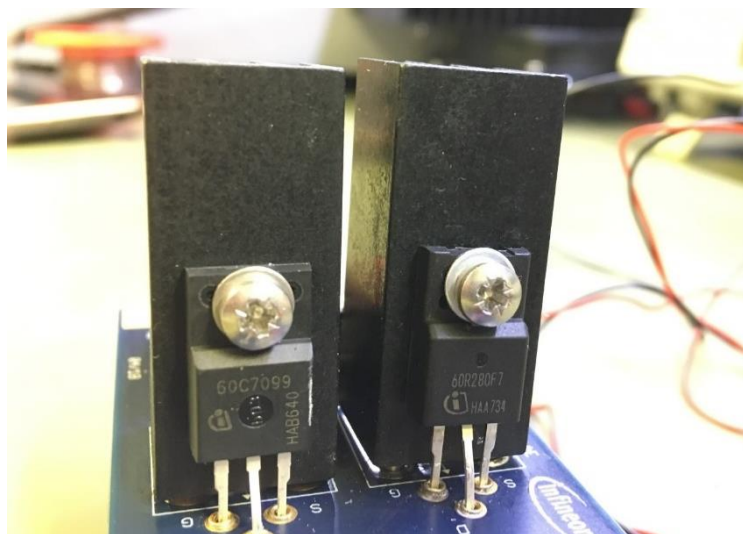
$$C_{LOAD} \approx 2.8 nF$$





# MOSFET Replacement

IPA60R099C7 → IPA60R280CFD7

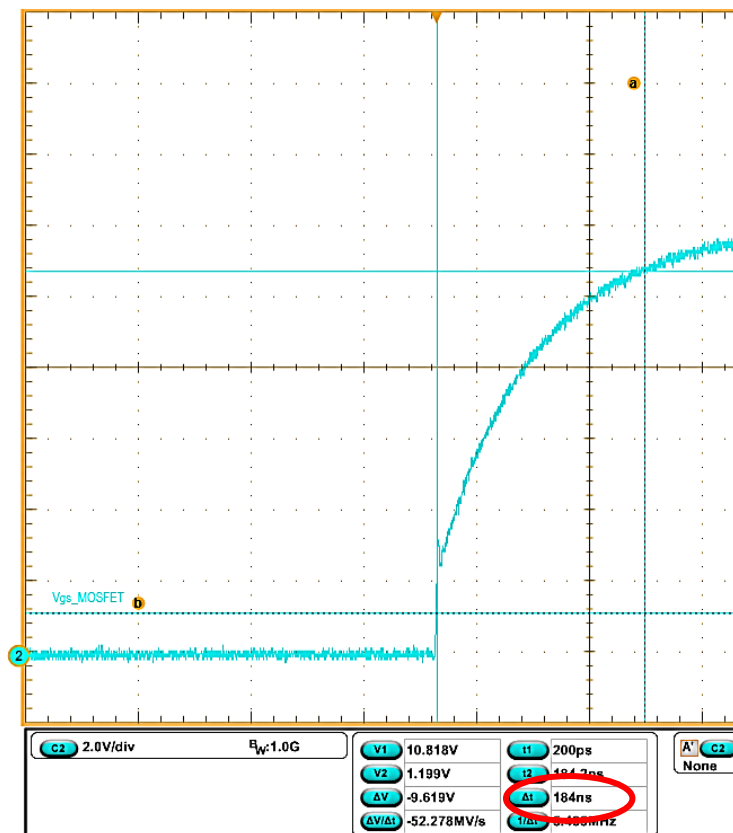


Gate to drain charge	$Q_{gd}$	-	5	-	nC	$V_{DD}=400V, I_D=5.0A, V_{GS}=0 \text{ to } 10V$
Gate charge total	$Q_g$	-	18	-	nC	$V_{DD}=400V, I_D=5.0A, V_{GS}=0 \text{ to } 10V$

$$C_{LOAD} \approx \frac{13 \text{ nC}}{10 \text{ V}} = 1.3 \text{ nF for } V_{GS} = 12 \text{ V}$$



# Rise/fall times: New MOSFET



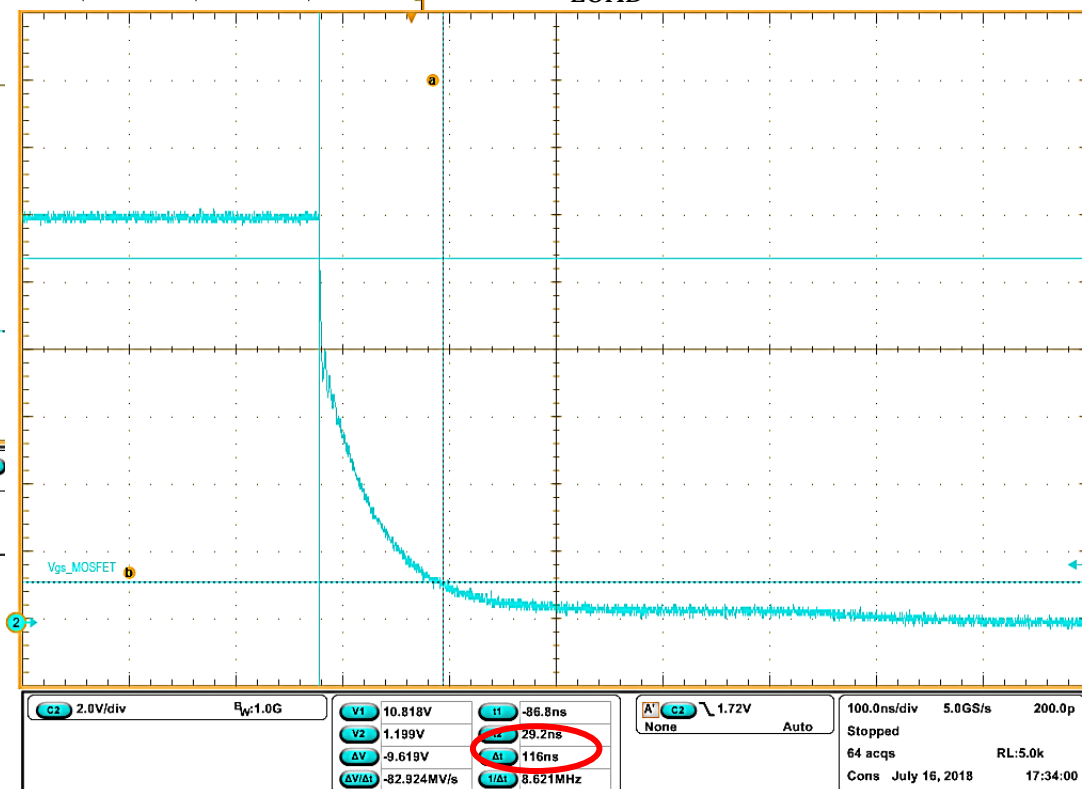
$$R_{G,SOURCE} = 51 \Omega$$

$$R_{G,SINK} = 43 \Omega$$

MOSFET =  
IPA60R280CFD7

$$R_{G,MOSFET} = 11 \Omega$$

$$C_{LOAD} \approx 1.3 \text{ nF}$$





# MOSFET replacement

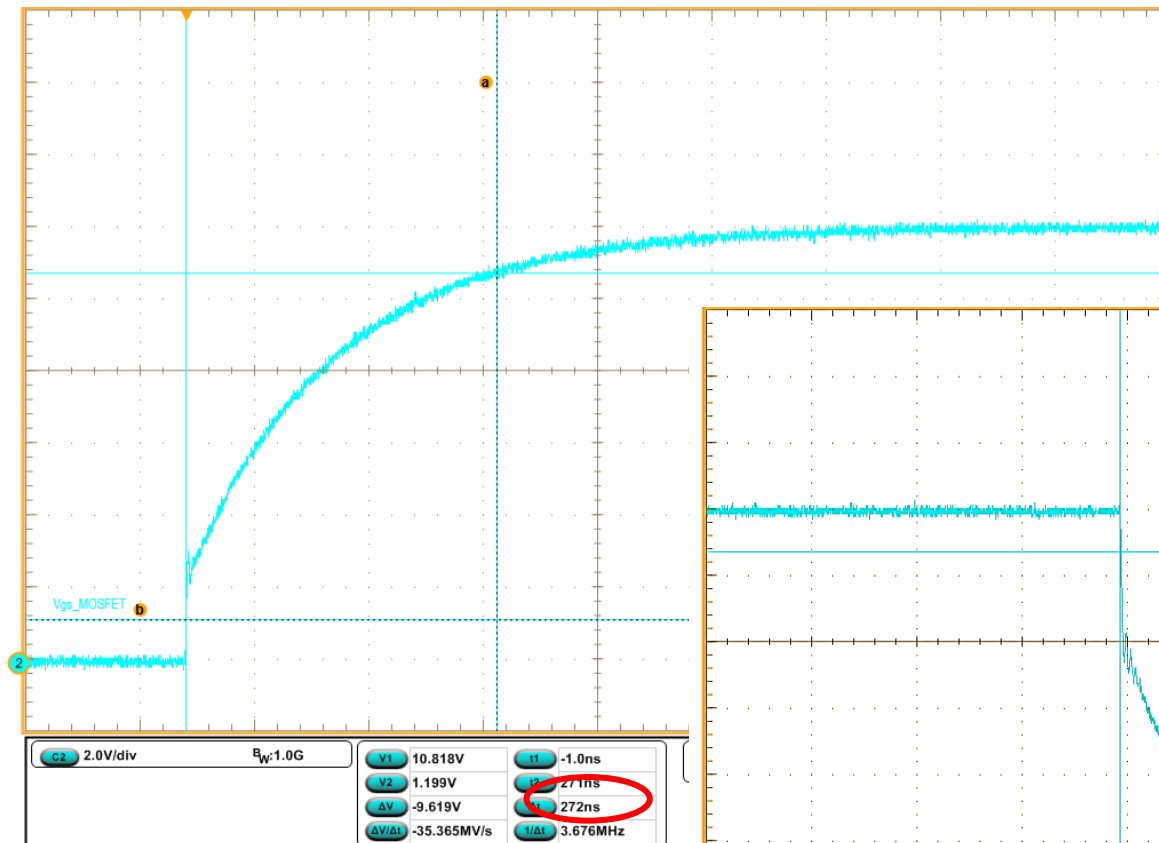
IPA60R280CFD7 → IPA60R180P7

Gate to drain charge	$Q_{gd}$	-	8	-	nC	$V_{DD}=400V, I_D=5.6A, V_{GS}=0 \text{ to } 10V$
Gate charge total	$Q_g$	-	25	-	nC	$V_{DD}=400V, I_D=5.6A, V_{GS}=0 \text{ to } 10V$

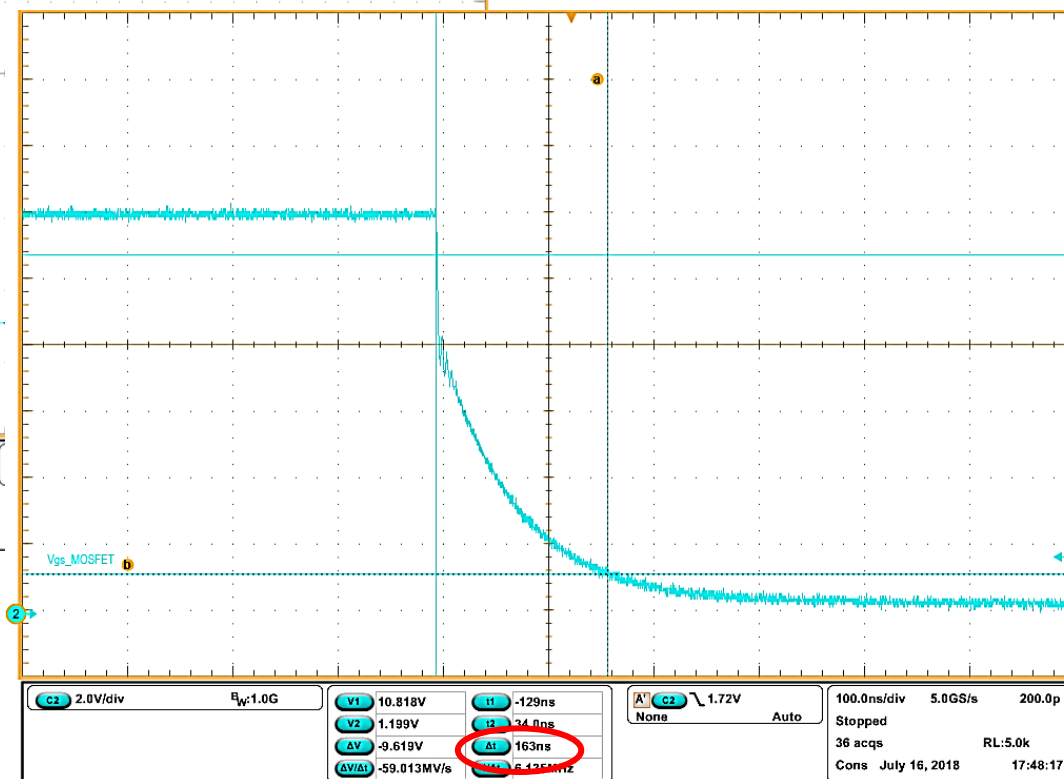
$$C_{LOAD} \approx \frac{19 \text{ nC}}{10 \text{ V}} = 1.9 \text{ nF for } V_{GS} = 12 \text{ V}$$



# Rise/fall times: New MOSFET



$R_{G,SOURCE} = 51 \Omega$   
 $R_{G,SINK} = 43 \Omega$   
**MOSFET = IPA60R180P7**  
 $R_{G,MOSFET} = 11 \Omega$   
 $C_{LOAD} \approx 1.9 \text{ nF}$





# Additional notes

- > Note that the MOSFET is not turned-on or -off, you are only charging/discharging the gate-to-source capacitance
- > Changing the gate resistors and the MOSFETs, you are changing the load for the driver
- > If you want to turn-on or turn-off the MOSFET, you must integrate the board in a proper circuit
- > You can not apply directly the voltage (e.g 400 V) across the MOSFET through the banana connectors on the board
- > You must limit the input current from the DC source generator → add an inductance
- > You must create a freewheeling path for the current when MOSFET is off

Example: boost converter, simple MOSFET in clamped inductive mode



# IMPORTANT NOTICE and WARNINGS

## IMPORTANT NOTICE

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application. For further information on the product, technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies office ([www.infineon.com](http://www.infineon.com)).

## WARNINGS

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.





Part of your life. Part of tomorrow.





# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Infineon:](#)

[KITDRIVER2EDN7524RTOBO1](#)